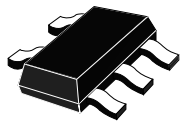
STMPS2141, STMPS2151, STMPS2161, STMPS2171

Enhanced single channel power switches

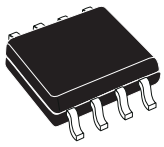
Datasheet −production data

Features

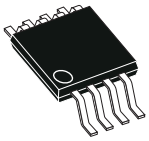
- 90 mΩ high-side MOSFET switch
- 500/1000 mA continuous current
- Thermal and short-circuit protection with overcurrent logic output
- Operating range from 2.7 to 5.5 V
- CMOS and TTL compatible enable input
- Undervoltage lockout (UVLO)
- 12 µA maximum standby supply current
- Ambient temperature range, -40 to 85 °C
- 8 kV ESD protection
- Reverse current protection
- Fault blanking
- UL recognized components (UL file number: E354278)



SOT23-5L



SO-8



MSOP8

Description

The STMPS2141, STMPS2151, STMPS2161, STMPS2171 power distribution switches are intended for applications where heavy capacitive loads and short-circuits are likely to be encountered. These devices incorporate 90 mΩ N-channel MOSFET high-side power switches for power distribution. These switches are controlled by a logic enable input.

When the output load exceeds the current limit threshold or a short is present, the device limits the output current to a safe level by switching into a constant current mode. When continuous heavy overloads and short-circuits increase the power dissipation in the switch, causing the junction temperature to rise, a thermal protection circuit shuts the switch off to prevent damage. Recovery from a thermal shutdown is automatic once the device has cooled sufficiently. Internal circuitry ensures the switch remains off until a valid input voltage is present.

Table 1. Device summary

Order codes			Rated continuous output current (mA)	Enable
SO-8	SOT23-5L	MSOP8[1]		
STMPS2141MTR	STMPS2141STR	STMPS2141TTR	500	Active low
STMPS2151MTR	STMPS2151STR	STMPS2151TTR	500	Active high
STMPS2161MTR	STMPS2161STR	STMPS2161TTR	1000	Active low
STMPS2171MTR	STMPS2171STR	STMPS2171TTR	1000	Active high

1. MSOP8 package is also known as “TSSOP8”.

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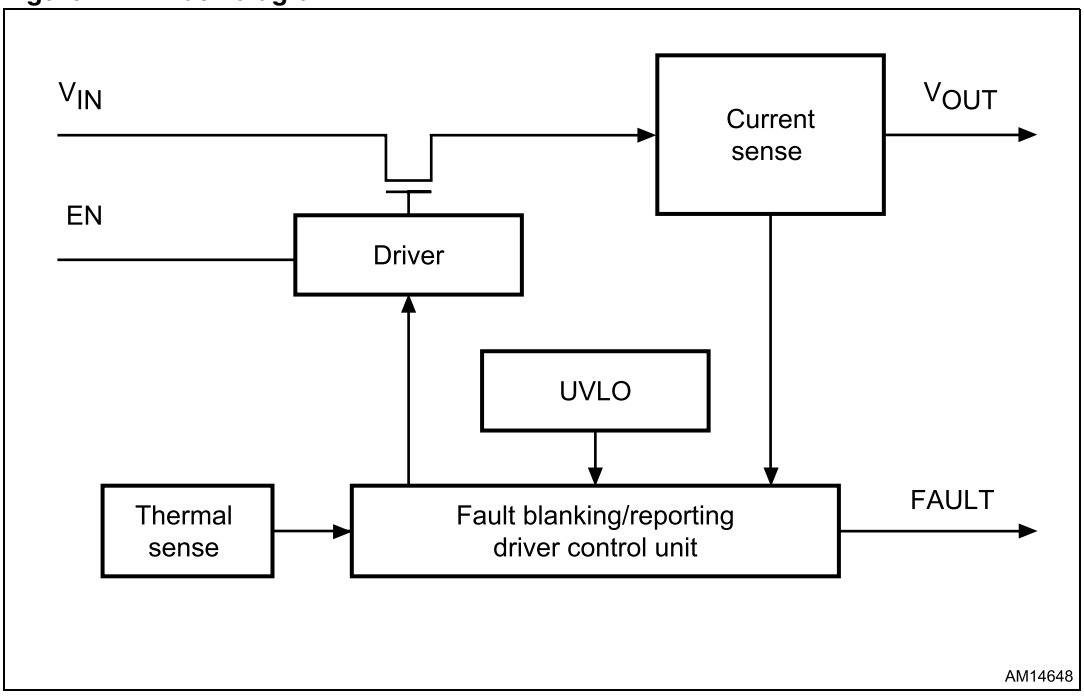
1 Block diagram

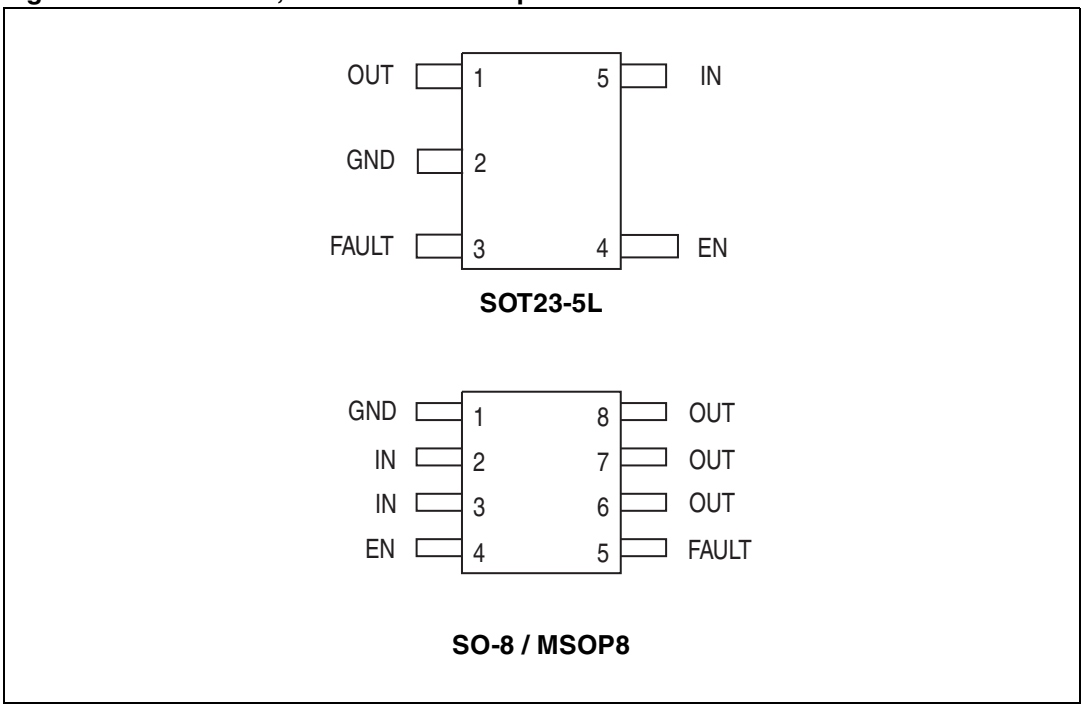
Figure 1. Block diagram



2 Pin settings

2.1 Pin connections

Figure 2. SOT23-5L, SO-8 and MSOP8 pin connections



2.2 Pin description

Table 2. Pin description

Pin number			Name	Function
SO-8	MSOP8	SOT23-5L		
1	1	2	GND	Ground
2	2	5	IN	2.7 - 5.5 V input
3	3	-	IN	2.7 - 5.5 V input
4	4	4	EN	Enable for power switch
5	5	3	FAULT	Open drain FAULT indicator, active low
6	6	1	OUT	Output of power switch
7	7	-	OUT	Output of power switch
8	8	-	OUT	Output of power switch

3 Functional description

3.1 Fault blanking

The STMPS devices feature a 10 ms fault blanking. Fault blanking allows current limit faults, including momentary short-circuit faults that occur when hot-swapping a capacitive load, and also ensures that no fault is issued during power-up. When a load transient causes the device to enter current limit, an internal counter starts. If the load fault persists beyond the 10 ms fault blanking timeout, the FAULT output asserts “low”. Load transient faults less than 10 ms (typ.) do not cause a FAULT output assertion. Only current limit faults are blanked. Die overtemperature faults and input voltage drops below the UVLO threshold cause an immediate fault output.

3.2 Overcurrent/overtemperature protection

In overcurrent or short-circuit condition, the switch limits the current at a value of about 120% of the rated current. If the temperature of the die goes above the limit value, the switch turns off.

3.3 Fault conditions

In power switch applications, 4 types of fault conditions are common. These fault conditions and the response of the STMPS21x1 power switches are described in *Table 3*.

Table 3. Fault conditions

Fault	Condition	STMPS21x1 action
Short-circuit	Output shorted to GND via resistance path of < 1 Ω causing a rapid current surge.	Reduces output voltage to reduce the current. Asserts FAULT pin after a blanking period
Overcurrent	Output connected to a load that sinks current above threshold.	Reduces output voltage to reduce the current. Asserts FAULT pin after a blanking period.
Overheating	Temperature of junction exceeds 135 °C due to any reason.	Turn OFF output until temperature falls below 125 °C. Asserts FAULT pin immediately.
Undervoltage	Input voltage drops below the UVLO threshold.	Turn OFF output until input voltage rises above the UVLO threshold plus hysteresis. Asserts FAULT pin immediately.

3.4 Reversed current blocking

When the switch is OFF (disabled through the EN pin), or when the STMPS device is unpowered (V_{IN} = 0 V) the switch behaves as an Hi-Z at the output pin, ensuring that no reverse current will flow into the device when $V_{IN} < V_{OUT}$.

Note: In the case where the switch is ON, and a voltage higher than V_{IN} is applied to the OUT pin, a reverse current occurs. This operating condition is not allowed.

3.5 UVLO

When the input voltage drops below critical values, the power switch turns off to prevent improper operation due to low voltage.

4 Ambient temperature

In “Enable” operating mode, an amount of power is dissipated as heat in the power switch due to the on-resistance. The power dissipation is: $P = I^2R$.

Table 4. SOT23-5L (191 °C/W)

Part number	Max. current	Max. R_{ON} at 5 V	Power dissipation	Temperature difference (junction - ambient)	Maximum ambient temperature (at junction temperature 125 °C)
STMPS2141	0.50 A	135 mΩ	33.8 mW	6.5	118.5
STMPS2151					
STMPS2161	1.00 A	135 mΩ	135.0 mW	25.8	99.2
STMPS2171					

Table 5. MSOP8 (220 °C/W)

Part number	Max. current	Max. R_{ON} at 5 V	Power dissipation	Temperature difference (junction - ambient)	Maximum ambient temperature (at junction temperature 125 °C)
STMPS2141	0.50 A	140 mΩ	35.0 mW	7.7	117.3
STMPS2151					
STMPS2161	1.00 A	140 mΩ	140.0 mW	30.8	94.2
STMPS2171					

Table 6. SO-8 (160 °C/W)

Part number	Max. current	Max. R_{ON} at 5 V	Power dissipation	Temperature difference (junction - ambient)	Maximum ambient temperature (at junction temperature 125 °C)
STMPS2141	0.50 A	140 mΩ	35.0 mW	5.6	119.4
STMPS2151					
STMPS2161	1.00 A	140 mΩ	140.0 mW	22.4	102.6
STMPS2171					

5 Maximum ratings

Stressing the device above the rating listed in *Table 7: Absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in *Section 5.2: Recommended operating conditions* of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

5.1 Absolute maximum ratings

Table 7. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{IN}	Input voltage range	–0.3 – 6.0	V
V_{OUT}	Output voltage range	–0.3 – (V_{IN} + 0.3)	V
V_{IENX}	EN Input voltage range	-0.3 – 6.0	V
I_{OUT}	Continuous output current	Internally limited	–
ESD	ESD protection level	8	kV
T_J	Junction operating temperature	–40 to 125	°C
T_{STG}	Storage temperature	–55 to 150	°C
T_R	Thermal resistance (MSOP8)	220	°C/W
T_R	Thermal resistance (SOT23-5L)	191	°C/W
T_R	Thermal resistance (SO-8)	160	°C/W

5.2 Recommended operating conditions

Table 8. Recommended operating conditions

Symbol	Parameter	Value			Unit
		Min.	Typ.	Max.	
V_{IN}	Input voltage	2.7	5.0	5.5	V
V_{OUT}	Output voltage	0	5.0	5.5	V
I_{OUT} (STMPS2141 STMPS2151)	Continuous output current	0	-	500	mA
I_{OUT} (STMPS2161 STMPS2171)	Continuous output current	0	-	1000	mA

6 Electrical specifications

Table 9. SOT-23-5L electrical characteristics

Symbol	Parameter	Test condition	Value			Unit
			Min.	Typ.	Max.	
R_{ON}	Static drain source ON state resistance SOT23-5L package load = 500 mA (STMPS2141/ STMPS2151) load = 1000 mA (STMPS2161/ STMPS2171)	V_{IN} = 2.7 V; T_J = 25 °C;	–	120	160	mΩ
		V_{IN} = 5.0 V; T_J = 25 °C;	–	90	110	mΩ
R_{ON}	Static drain source ON state resistance	V_{IN} = 2.7 V; -40 < T_J < 125 °C	–	–	200	mΩ
		V_{IN} = 5.0 V; -40 < T_J < 125 °C	–	–	135	
t_r	Output rise time	V_{IN} = 5.0 V R_L = 10 Ω C_L = 1 µF	0.05	–	2	ms

Table 10. MSO8P/SO-8 electrical characteristics

Symbol	Parameter	Test condition	Value			Unit
			Min.	Typ.	Max.	
R_{ON}	Static drain source ON state resistance SO-8 and MSO8 package load = 500 mA (STMPS2141/ STMPS2151) load = 1000 mA (STMPS2161/ STMPS2171)	V_{IN} = 2.7 V; T_J = 25 °C	–	130	170	mΩ
		V_{IN} = 5.0 V; T_J = 25 °C	–	110	125	mΩ
R_{ON}	Static drain source ON state resistance	V_{IN} = 2.7 V -40 < T_J < 125 °C	–	–	200	mΩ
		V_{IN} = 5.0 V -40 < T_J < 125 °C	–	–	140	
t_r	Output rise time	V_{IN} = 5.0 V R_L = 10 Ω C_L = 1 µF	0.05	–	2	ms

Table 11. Current limit characteristics (V_{IN} = 5.5 V, I_{OUT} = rated current, T_J = 25 °C, unless otherwise specified)

Symbol	Parameter	Test condition	Value			Unit
			Min.	Typ.	Max.	
I_{OS} (STMPS2141 STMPS2151)	Overcurrent limiting threshold	V_{IN} = 5.5 V V_{OUT} = 5.0 V	0.60	0.80	1.00	A
I_{OS} (STMPS2161 STMPS2171)	Overcurrent limiting threshold		1.10	1.50	1.90	A
I_{OS} (2141, 2151)	Short-circuit output current	V_{IN} = 5.5 V, OUT connected to GND, device enabled into short-circuit	–	–	0.9	A
I_{OS} (2161, 2171)	Short-circuit output current		–	–	1.8	A

Table 12. Supply current characteristics (V_{IN} = 5.5 V, I_{OUT} = rated current, T_J = 25 °C, unless otherwise specified)

Symbol	Parameter	Test condition	Value			Unit
			Min.	Typ.	Max.	
I_{OFF}	Switch turned off	No load	–	6.0	12	µA
		No load; -40 < T_J < 125 °C	–	–	15	
I_{ON}	Switch turned on	No load	–	40	60	µA
		No load; -40 < T_J < 125 °C	–	–	70	
$I_{leakage}$	Output leakage current(1)	Output grounded, switch is OFF	–	–	2	µA
		Output grounded, switch is OFF; -40 < T_J < 125 °C	–	–	5	
$I_{reverse}$	Reversed leakage current	Switch is off, V_{IN} < V_{OUT}, output connected to 5.5 V, 25 °C	–	0.5	2	µA
		Switch is off, V_{IN} < V_{OUT}, output connected to 5.5 V, 125 °C	–	0.5	3	

1. $I_{leakage}$ = $I_{OFF\text{-}ground}$ - I_{OFF}, where $I_{OFF\text{-}ground}$ = current into V_{IN} when switch is off and output is grounded.

Table 13. Thermal characteristics
(V_{IN} = 5.5 V, I_{OUT} = rated current, T_J = 25 °C, unless otherwise specified)

Symbol	Parameter	Test condition	Value			Unit
			Min.	Typ.	Max.	
T1	Thermal shutdown threshold		–	–	145	°C
T2	Recovery from thermal shutdown		120	–	–	°C
Hysteresis	-		–	14	–	°C

Table 14. UVLO characteristics
(V_{IN} = 5.5 V, I_{OUT} = rated current, T_J = 25 °C, unless otherwise specified)

Symbol	Parameter	Test condition	Value			Unit
			Min.	Typ.	Max.	
V_{UVLO}	Undervoltage lockout threshold		2.0	–	2.5	V
Hysteresis	-		40	75	110	mV

Table 15. FAULT pin characteristics
(V_{IN} = 5.5 V, I_{OUT} = rated current, T_J = 25 °C, unless otherwise specified)

Symbol	Parameter	Test condition	Value			Unit
			Min.	Typ.	Max.	
OC blanking	FAULT assertion and de-assertion		4	8	15	ms
V_{OUT}	Output low voltage	I_{OUT} = 5 mA	–	–	0.4	V
I_{OFF}	Off current	V_{FAULT} = 2.7 V, 5.5 V (no OC condition)	–	–	1.0	µA

Table 16. EN pin characteristics
(V_{IN} = 5.5 V, I_{OUT} = rated current, T_J = 25 °C, unless otherwise specified)

Symbol	Parameter	Test condition	Value			Unit
			Min.	Typ.	Max.	
V_{IH}	High level input voltage	V_{IN} = 2.7 to 5.5 V	2.0	–	–	V
V_{IL}	Low level input voltage	V_{IN} = 4.5 to 5.5 V	–	–	0.8	V
		V_{IN} = 2.7 to 4.5 V	–	–	0.4	V
I_{IN}	Input current	V_{IEN} = 0 V or V_{IN}	-0.5	–	0.5	µA
t_{ON}	Turn-ON time(1)	R_L = 10 Ω C_L = 100 µF	–	–	5	ms
t_{OFF}	Turn-OFF time(1)	R_L = 10 Ω C_L = 100 µF	–	–	10	ms

1. Not tested in production, specified by design.

7 Detail device characteristics

7.1 STMPS2141, STMPS2151 additional electrical charts

The waveforms displayed in *Section 7.1* are captured with the STMPS2141 device. The STMPS2151 device is expected to have the same characteristics with EN in the opposite polarity.

7.1.1 Turn-on/off characteristics at V_{OUT} = 5.0 V

Figure 3. Voltage output turn-on delay time (STMPS2141/2151, 5 V)

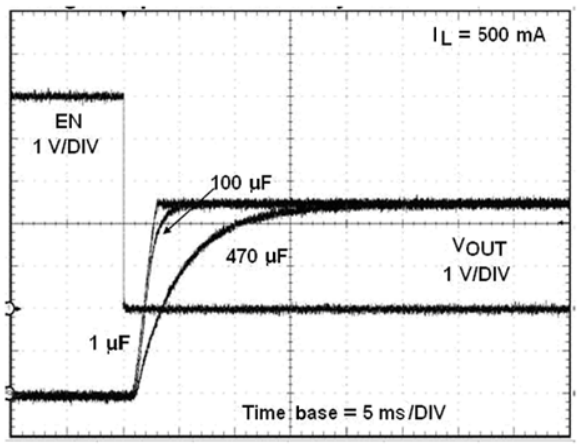


Figure 4. Voltage output turn-off delay time (STMPS2141/2151, 5 V)

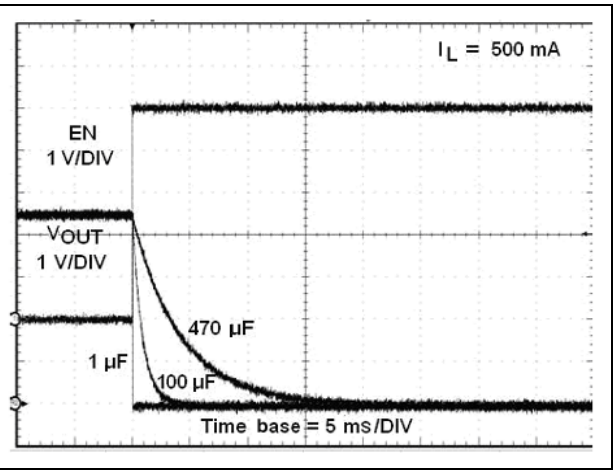


Figure 5. Current output turn-on delay time (STMPS2141/2151, 5 V)

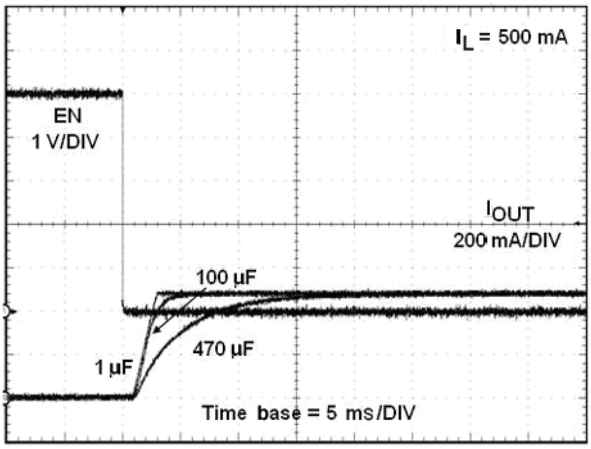
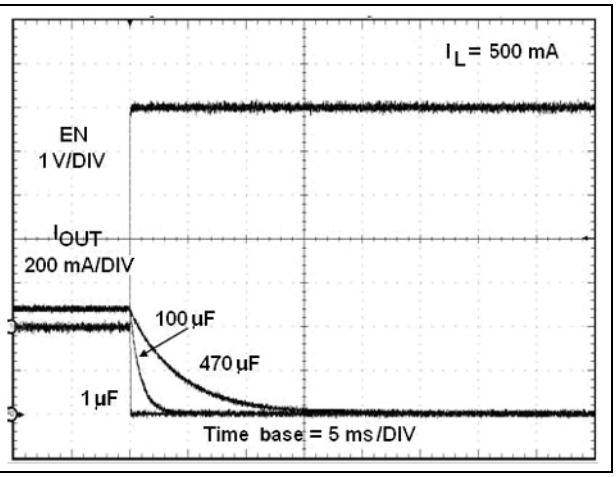


Figure 6. Current output turn-off delay time (STMPS2141/2151, 5 V)



7.1.2 Turn-on/off characteristics at V_{OUT} = 3.0 V

Figure 7. Voltage output turn-on delay time (STMPS2141/2151, 3 V)

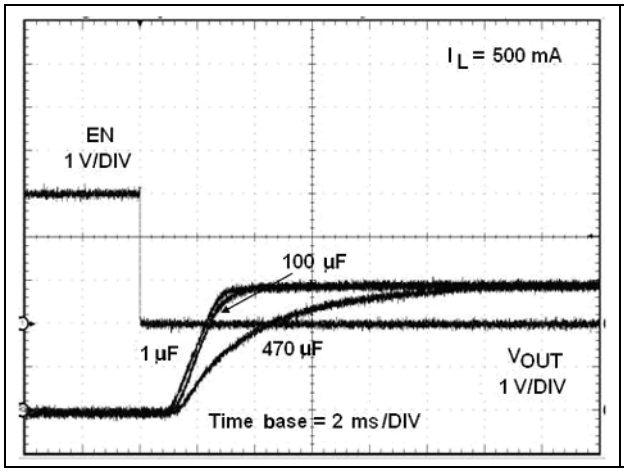


Figure 8. Voltage output turn-off delay time (STMPS2141/2151, 3 V)

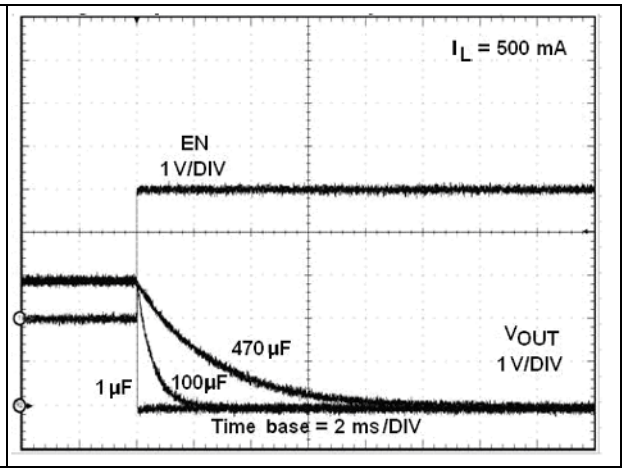


Figure 9. Current output turn-on delay time (STMPS2141/2151, 3 V)

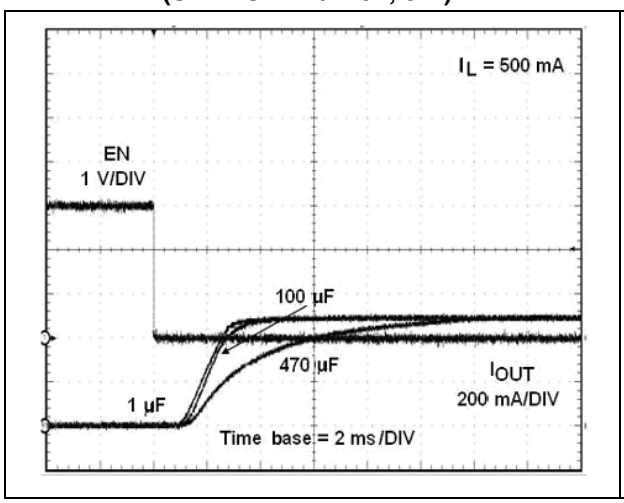
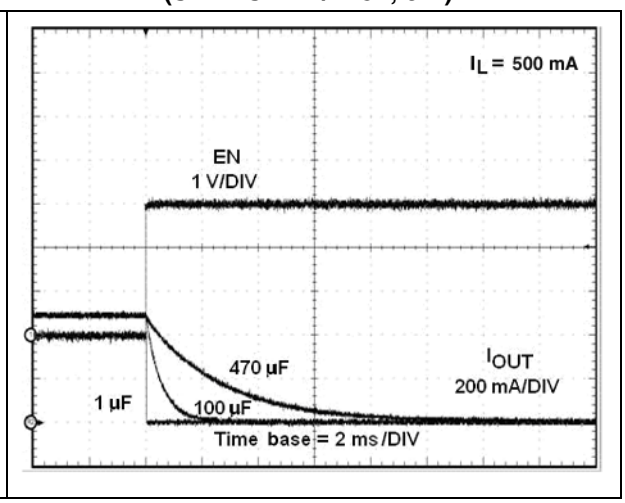


Figure 10. Current output turn-off delay time (STMPS2141/2151, 3 V)



7.1.3 UVLO

Figure 11. UVLO rising (STMPS2141/2151)

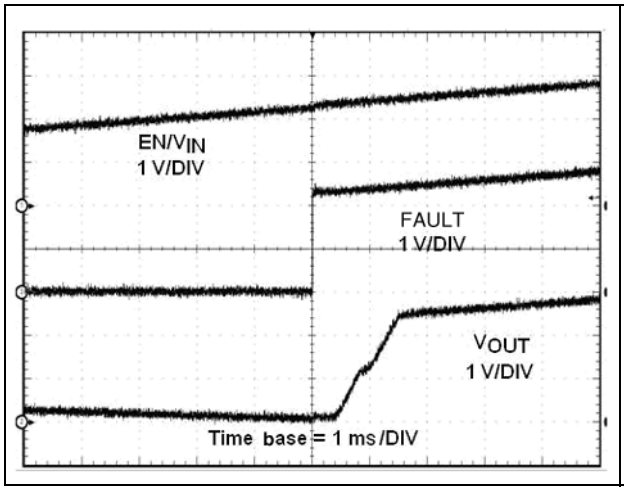
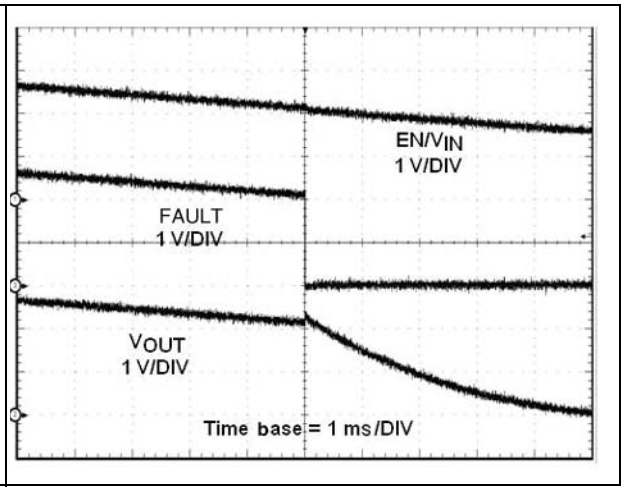


Figure 12. UVLO falling (STMPS2141/2151)



7.1.4 OC protection characteristics

Figure 13. OC protection at V_{OUT} = 3.0 V (STMPS2141/2151)

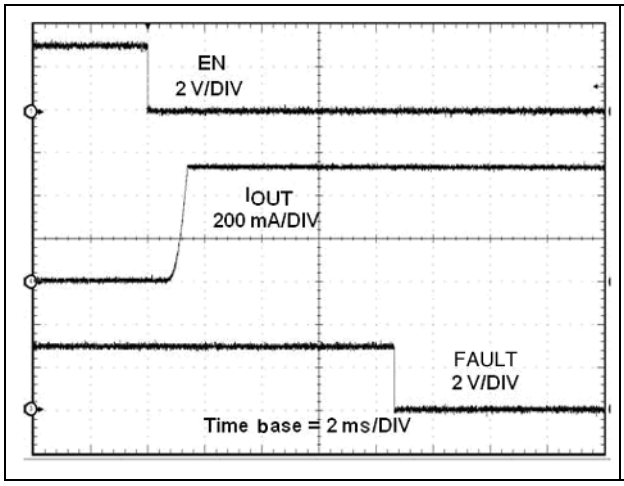


Figure 14. OC protection at V_{OUT} = 3.0 V (STMPS2141/2151 - detail)

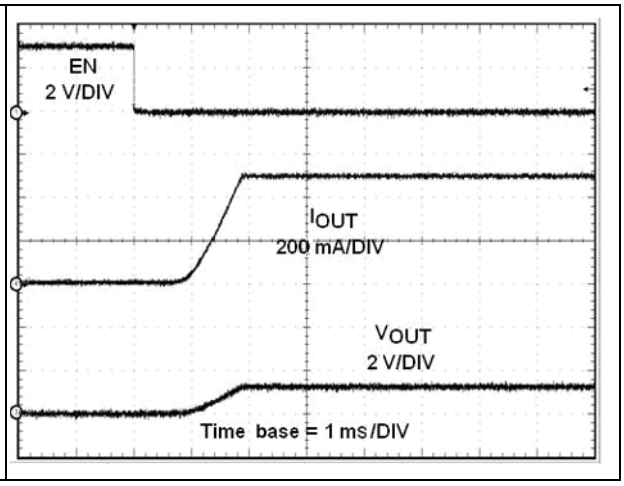


Figure 15. OC protection at V_{OUT} = 5.0 V (STMPS2141/2151)

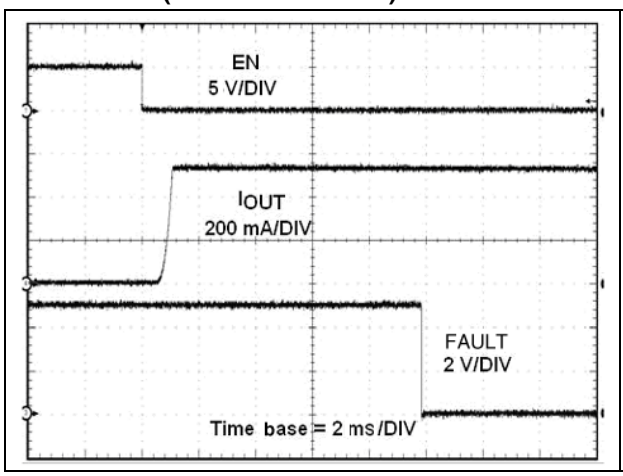
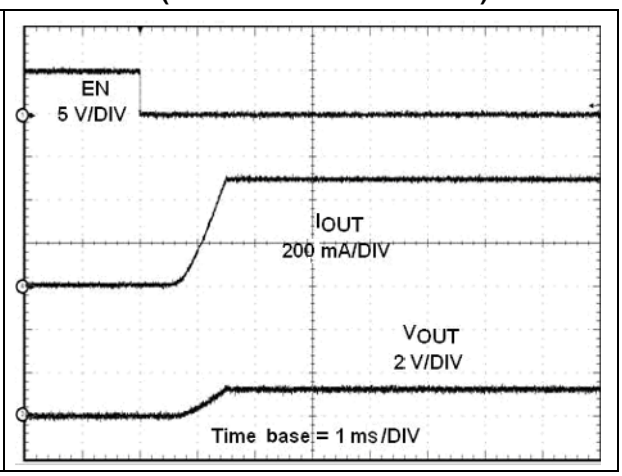


Figure 16. OC protection at V_{OUT} = 5.0 V (STMPS2141/2151 - detail)



7.1.5 Other electrical characteristics

Figure 17. I_{CC} vs. V_{IN} (enabled) (STMPS2141/2151)

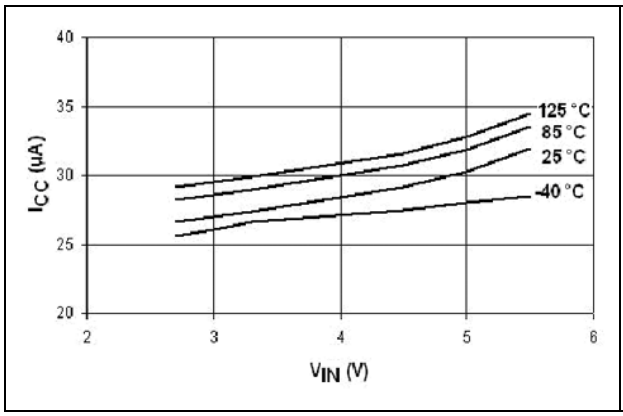


Figure 18. I_{CC} vs. temperature (enabled) (STMPS2141/2151)

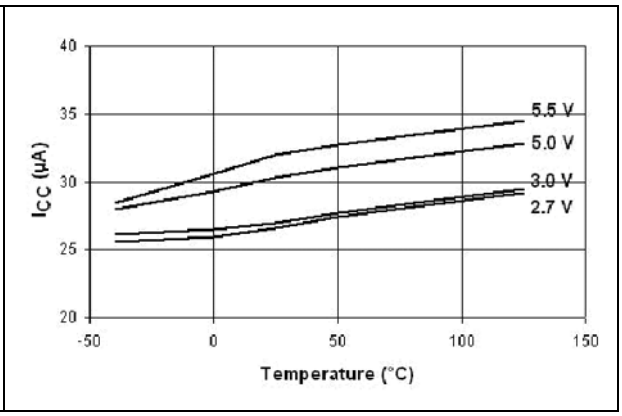


Figure 19. I_{CC} vs. V_{IN} (disabled) (STMPS2141/2151)

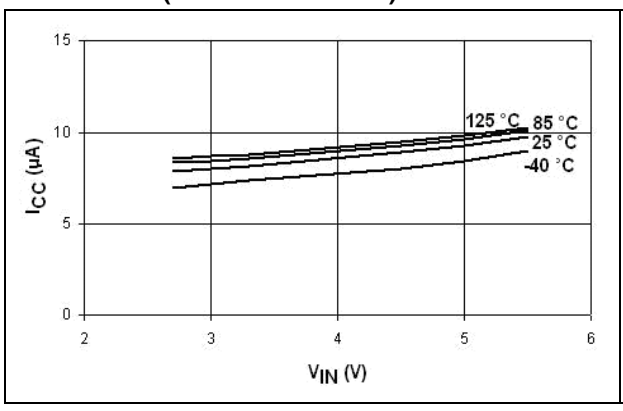


Figure 20. I_{CC} vs. temperature (disabled) (STMPS2141/2151)

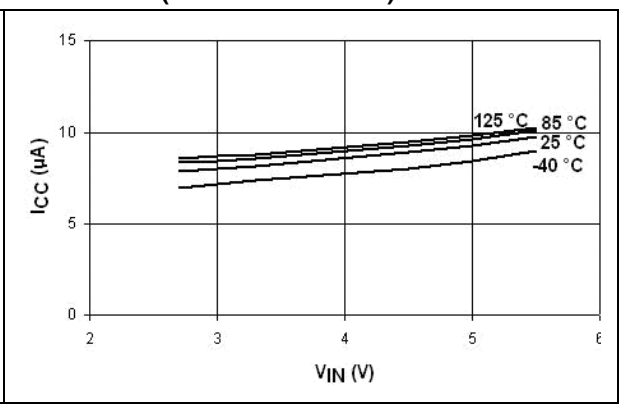


Figure 21. R_{ON} vs. V_{IN} (STMPS2141/2151)

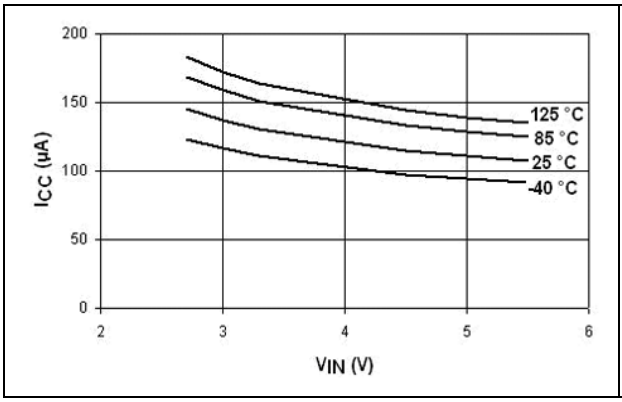


Figure 22. R_{ON} vs. temperature (STMPS2141/2151)

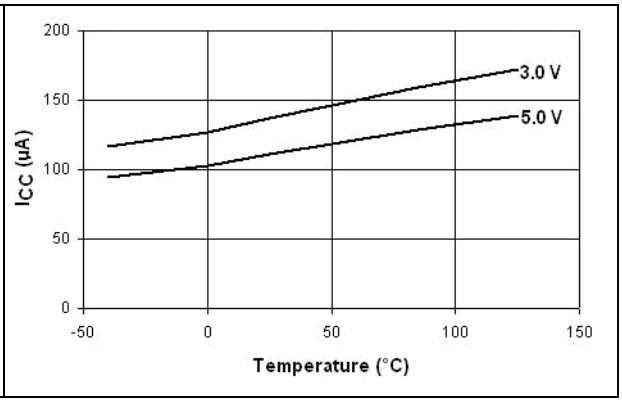


Figure 23. I_{OS} vs. temperature (STMPS2141/2151)

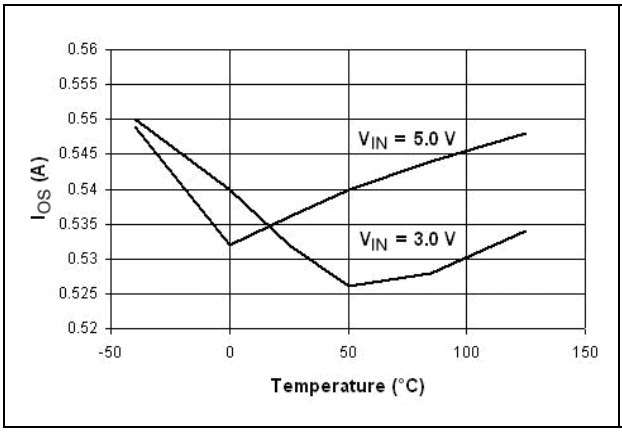


Figure 24. Switch leakage vs. temperature (STMPS2141/2151)

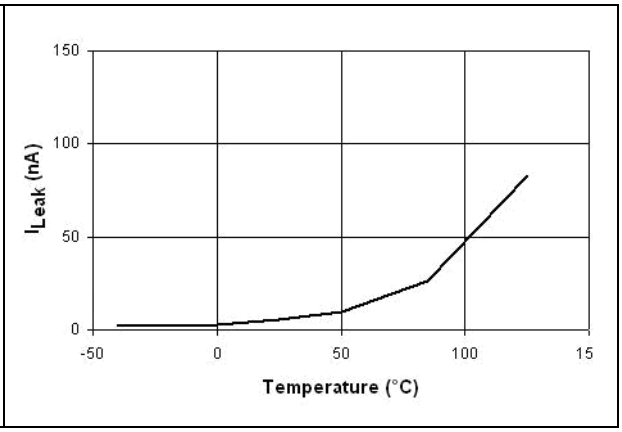


Figure 25. Output rise time vs. V_{IN} (STMPS2141/2151)

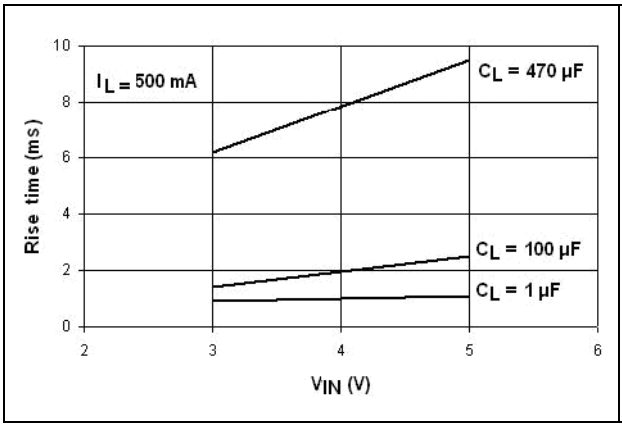


Figure 26. Output fall time vs. V_{IN} (STMPS2141/2151)

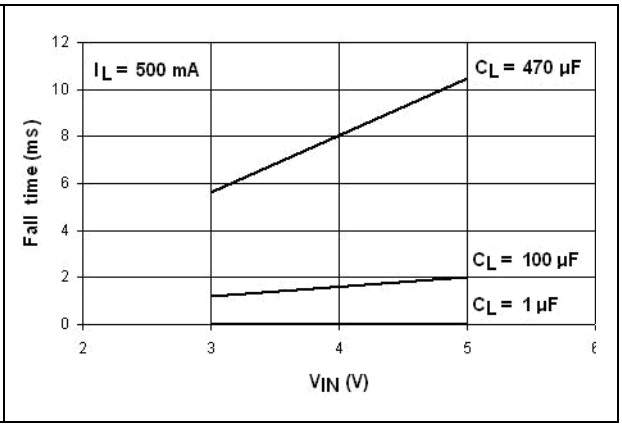
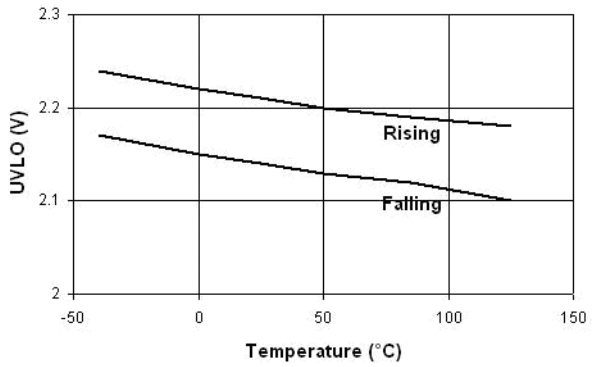


Figure 27. UVLO vs. temperature (STMPS2141/2151)



7.2 STMPS2161, STMPS2171 electrical charts

The waveforms displayed in *Section 7.2* are captured with the STMPS2161 device. The STMPS2171 device is expected to have the same characteristics with EN in the opposite polarity.

7.2.1 Turn-on/off characteristics at V_{OUT} = 5.0 V

Figure 28. Voltage output turn-on delay time (STMPS2161/2171, 5 V)

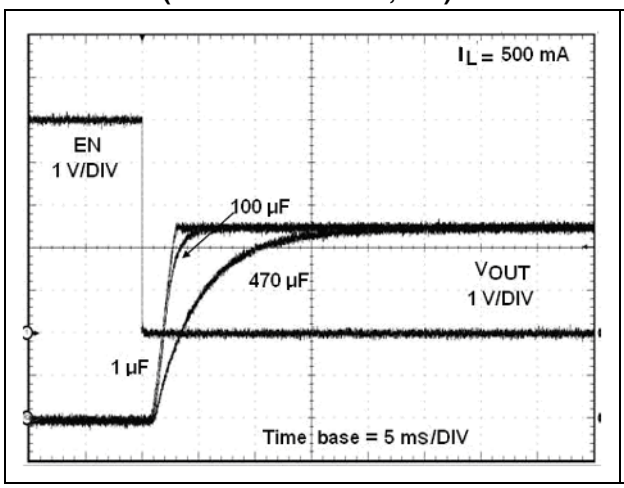


Figure 29. Voltage output turn-off delay time (STMPS2161/2171, 5 V)

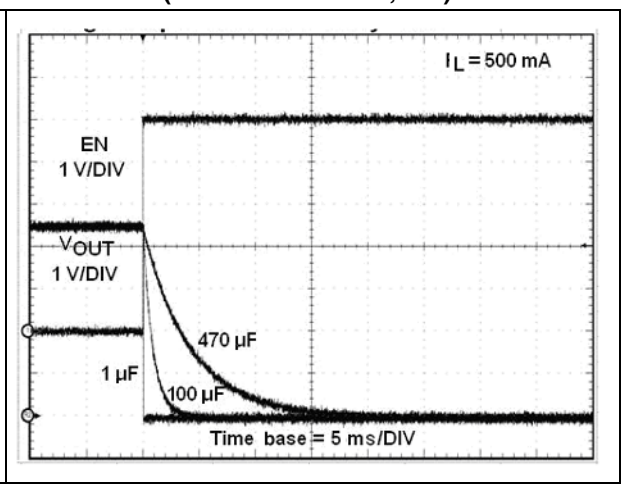


Figure 30. Current output turn-on delay time (STMPS2161/2171, 5 V)

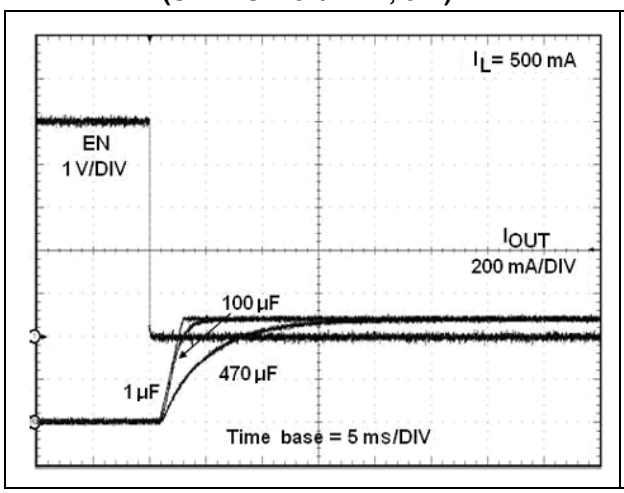
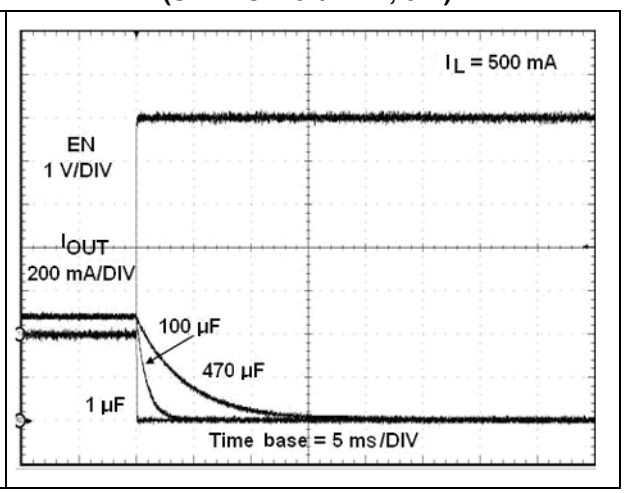


Figure 31. Current output turn-off delay time (STMPS2161/2171, 5 V)



7.2.2 Turn-on/off characteristics at V_{OUT} = 3.0 V

Figure 32. Voltage output turn-on delay time (STMPS2161/2171, 3 V)

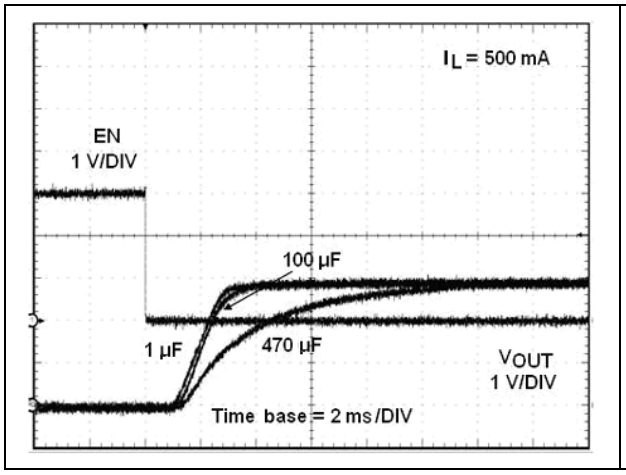


Figure 33. Voltage output turn-off delay time (STMPS2161/2171, 3 V)

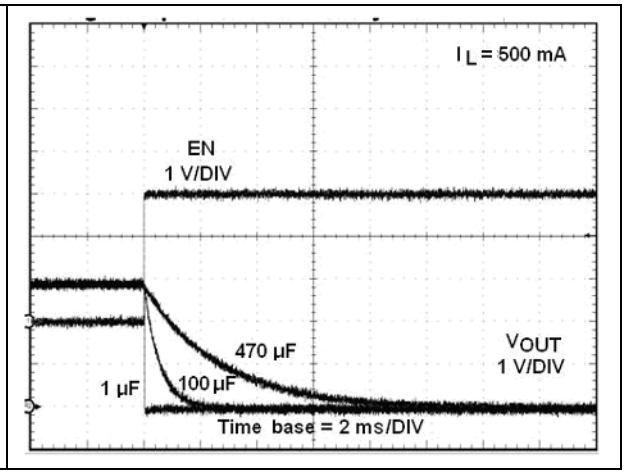


Figure 34. Current output turn-on delay time (STMPS2161/2171, 3 V)

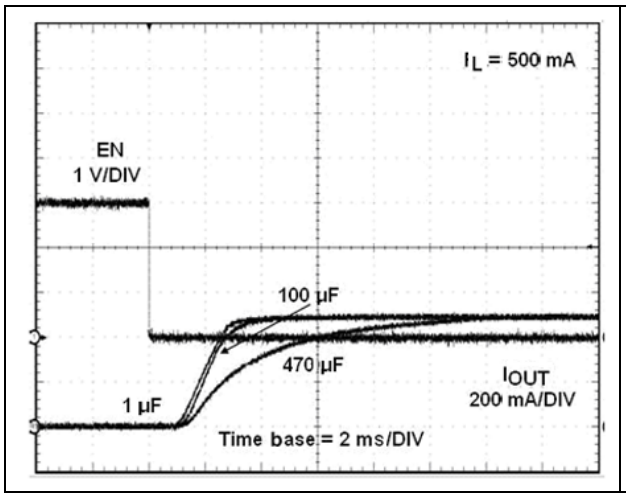
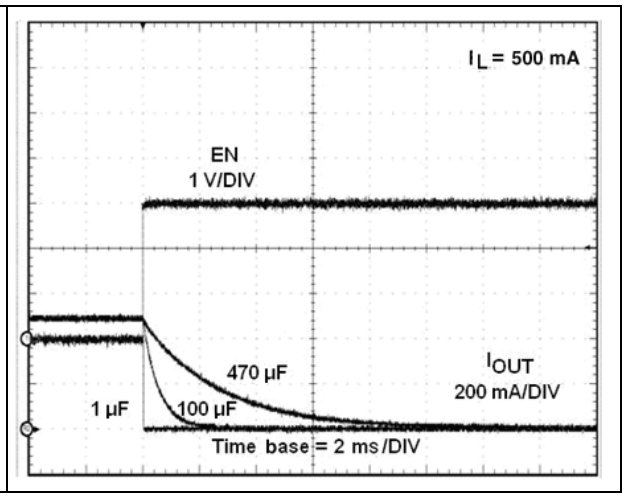


Figure 35. Current output turn-off delay time (STMPS2161/2171, 3 V)



7.2.3 UVLO

Figure 36. UVLO rising (STMPS2161/2171)

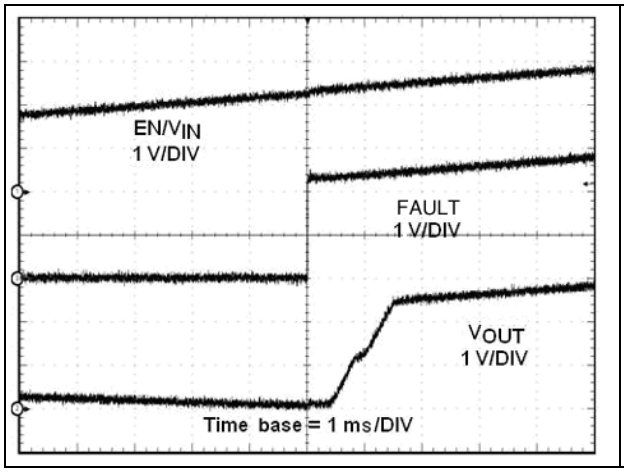
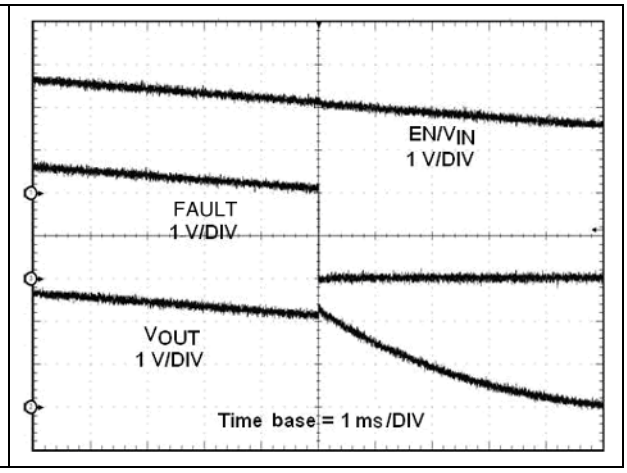


Figure 37. UVLO falling (STMPS2161/2171)



7.2.4 OC protection characteristics

Figure 38. OC protection at V_{OUT} = 3.0 V (STMPS2161/2171)

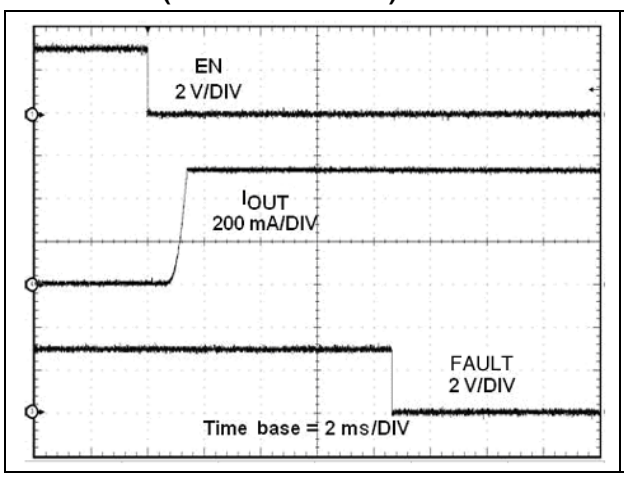


Figure 39. OC protection at V_{OUT} = 3.0 V (STMPS2161/2171- detail)

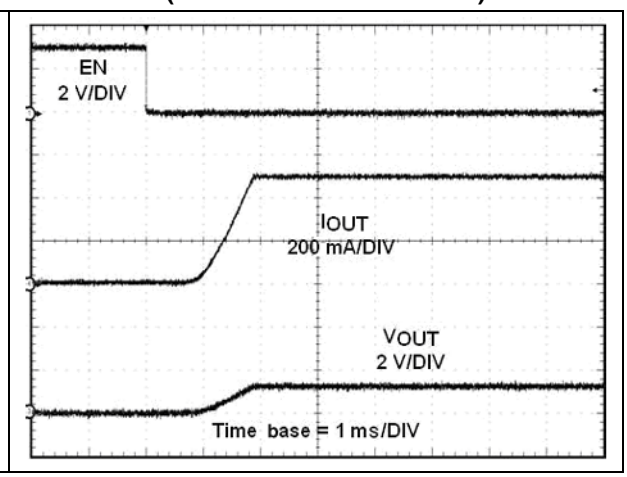


Figure 40. OC protection at V_{OUT} = 5.0 V (STMPS2161/2171)

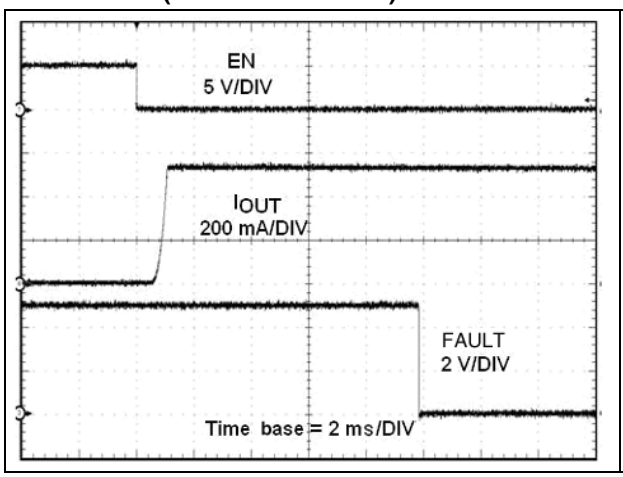
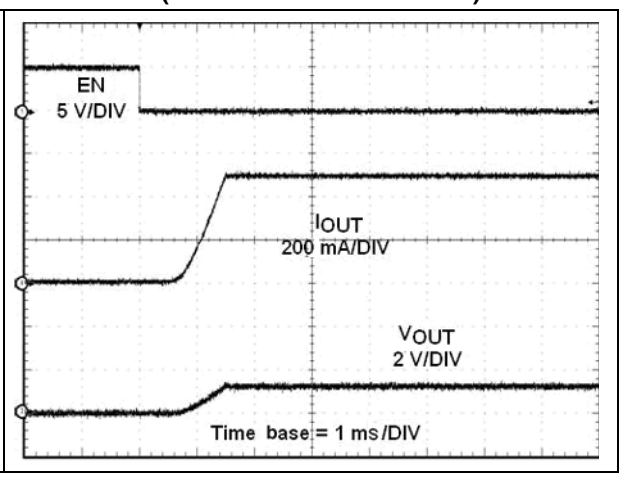


Figure 41. OC protection at V_{OUT} = 5.0 V (STMPS2161/2171- detail)



7.2.5 Other electrical characteristics

Figure 42. I_{CC} vs. V_{IN} (enabled) (STMPS2161/2171)

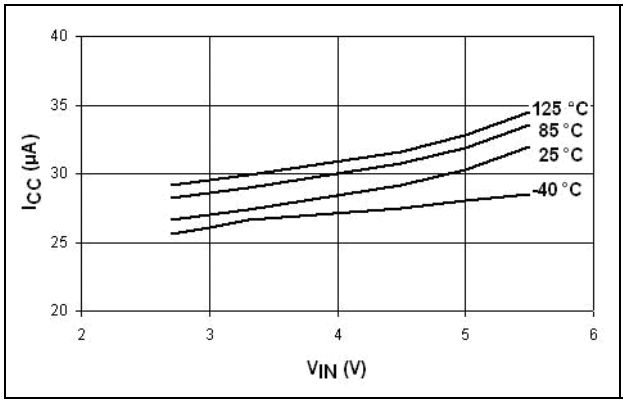


Figure 43. I_{CC} vs. temperature (enabled) (STMPS2161/2171)

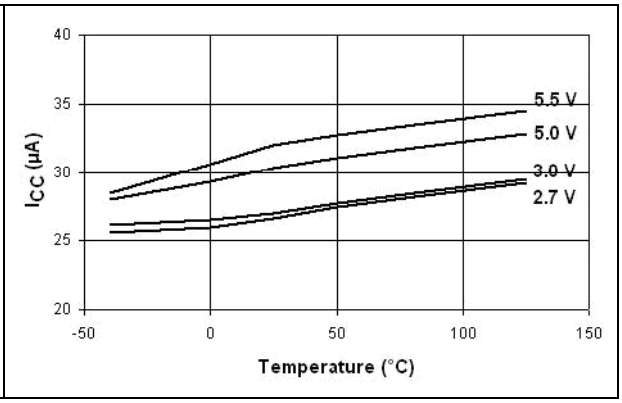


Figure 44. I_{CC} vs. V_{IN} (disabled) (STMPS2161/2171)

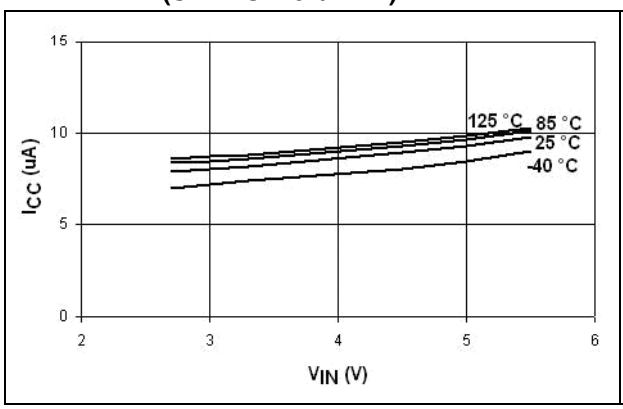


Figure 45. I_{CC} vs. temperature (disabled) (STMPS2161/2171)

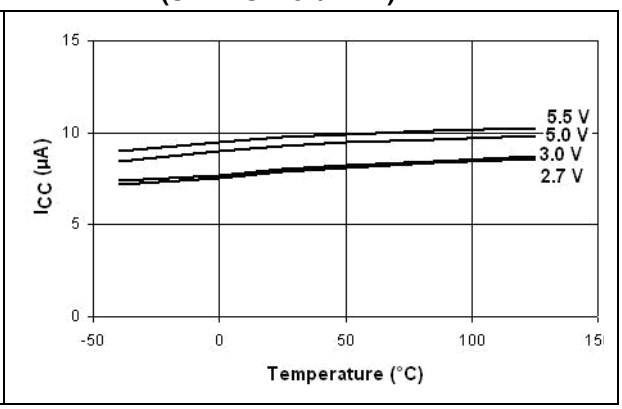


Figure 46. R_{ON} vs. V_{IN} (STMPS2161/2171)

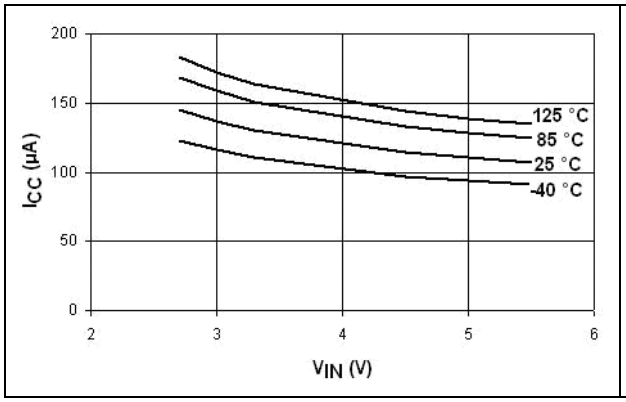


Figure 47. R_{ON} vs. temperature (STMPS2161/2171)

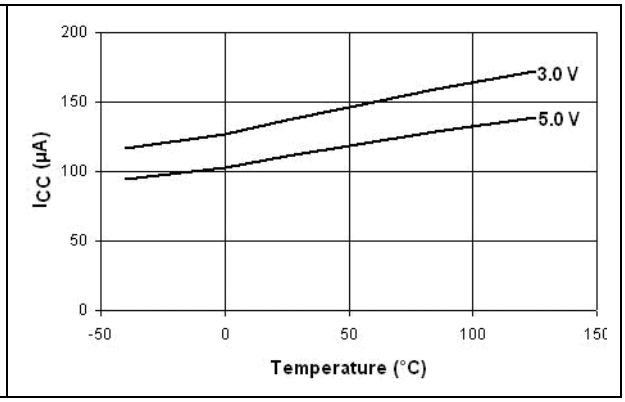


Figure 48. I_{OS} vs. temperature (STMPS2161/2171)

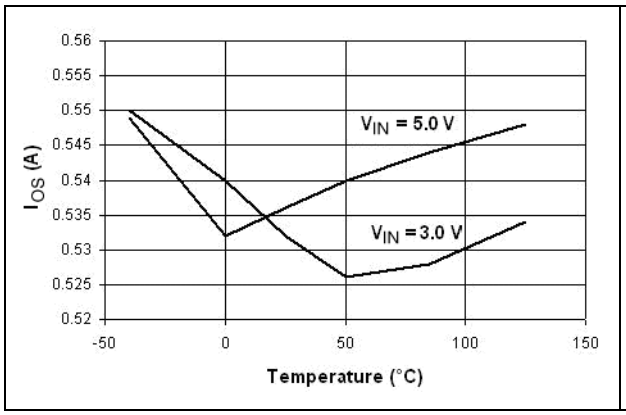


Figure 49. Switch leakage vs. temperature (STMPS2161/2171)

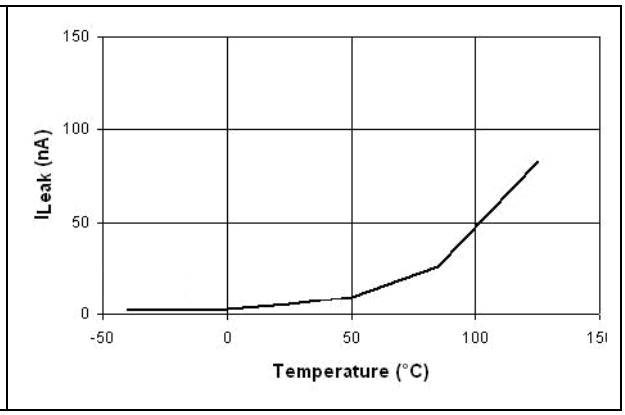


Figure 50. Output rise time vs. V_{IN} (STMPS2161/2171)

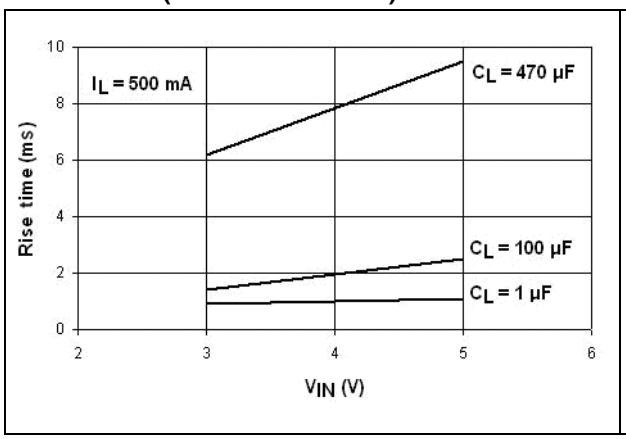


Figure 51. Output fall time vs. V_{IN} (STMPS2161/2171)

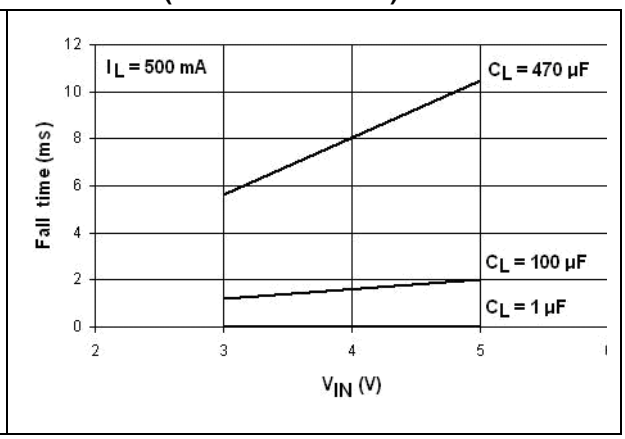
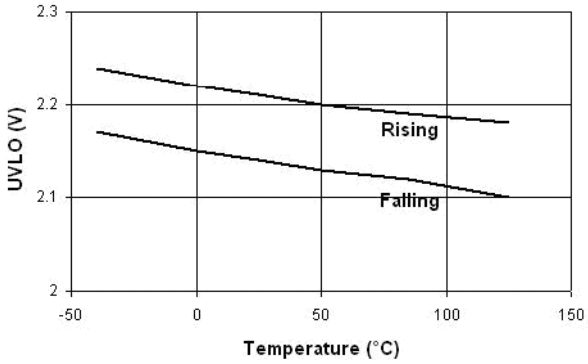


Figure 52. UVLO vs. temperature (STMPS2161/2171)



8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.

Figure 53. SOT23-5L package outline

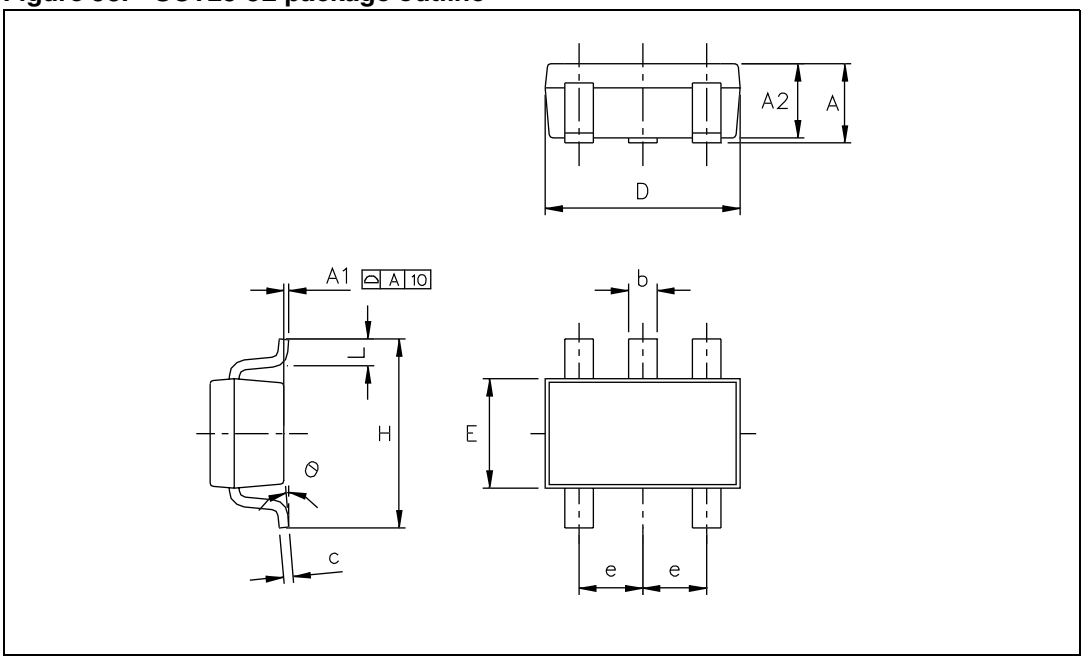


Table 17. SOT23-5L package mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90	–	1.45	35.4	–	57.1
A1	0.00	–	0.10	0.0	–	3.9
A2	0.90	–	1.30	35.4	–	51.2
b	0.35	–	0.50	13.7	–	19.7
C	0.09	–	0.20	3.5	–	7.8
D	2.80	–	3.00	110.2	–	118.1
E	1.50	–	1.75	59.0	–	68.8
e	–	0.95	–	–	37.4	–
H	2.60	–	3.00	102.3	–	118.1
L	0.10	–	0.60	3.9	–	23.6

Figure 54. SOT23-5L footprint recommendations

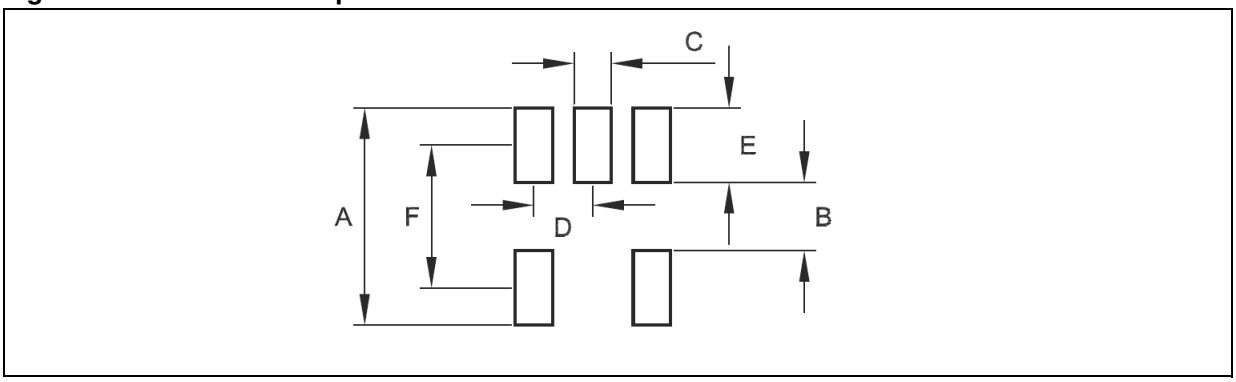


Table 18. SOT23-5L footprint dimensions

Footprint data		
Symbol	Dimensions	
	Millimeters	Inches
A	3.50	0.138
B	1.10	0.043
C	0.60	0.024
D	0.95	0.037
E	1.20	0.047
F	2.30	0.090

Figure 55. SOT23-5L carrier tape

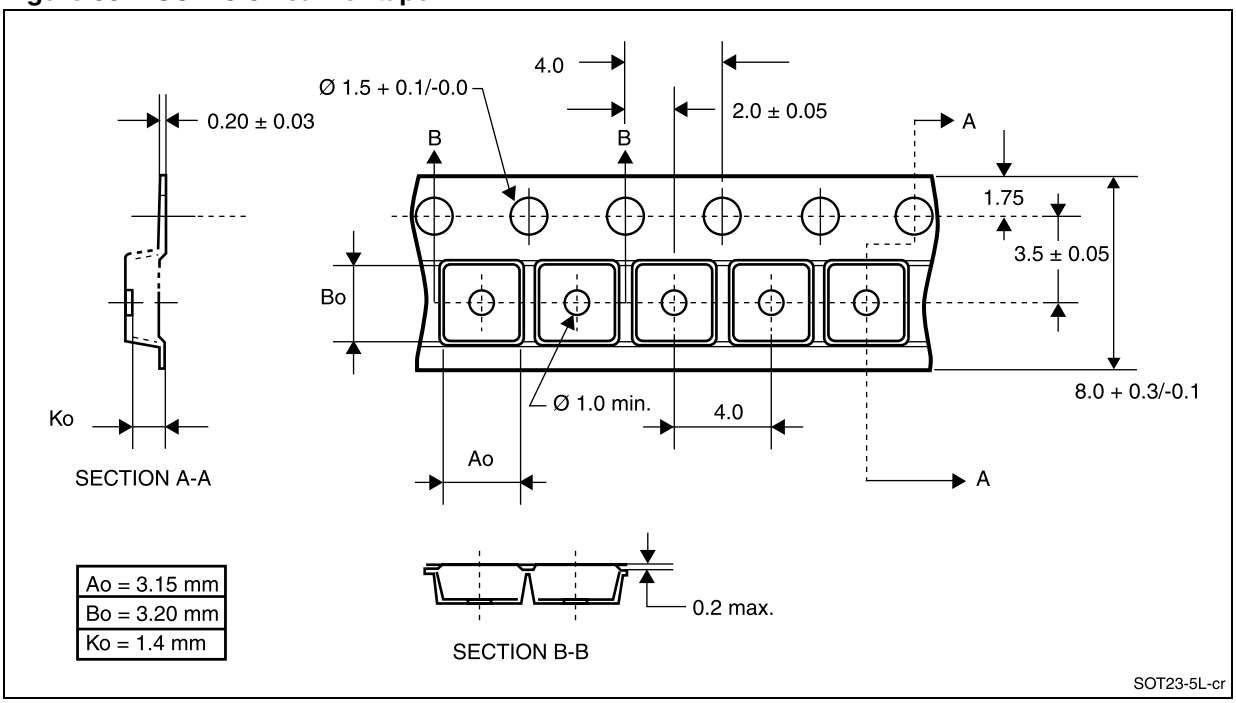
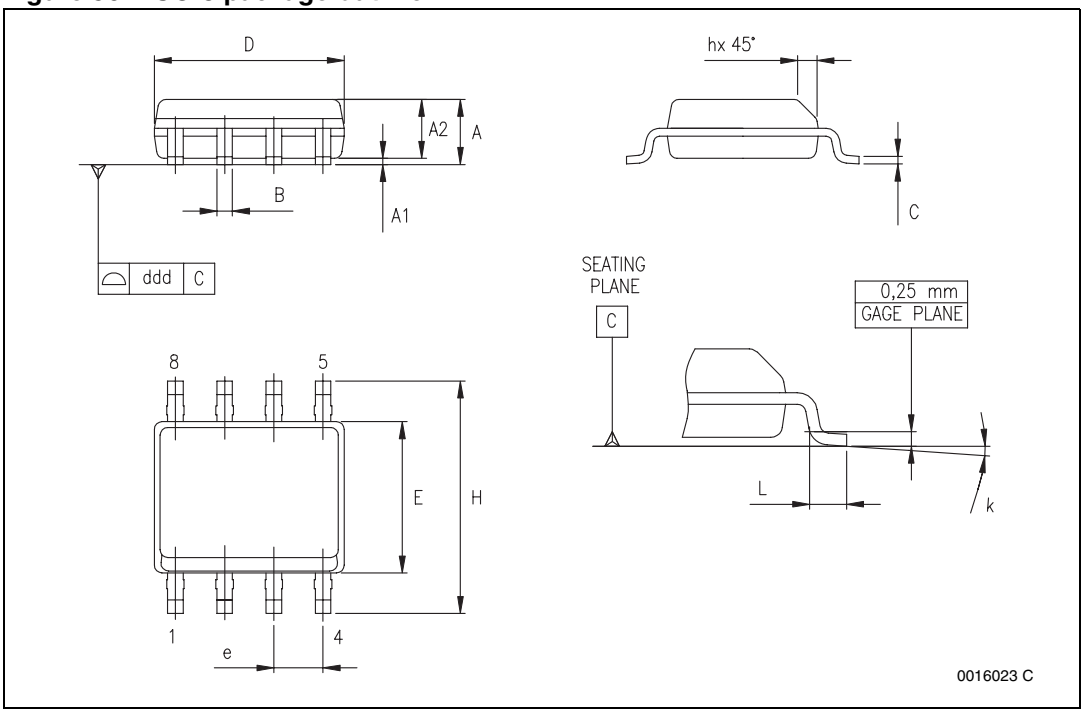


Figure 56. SO-8 package outline



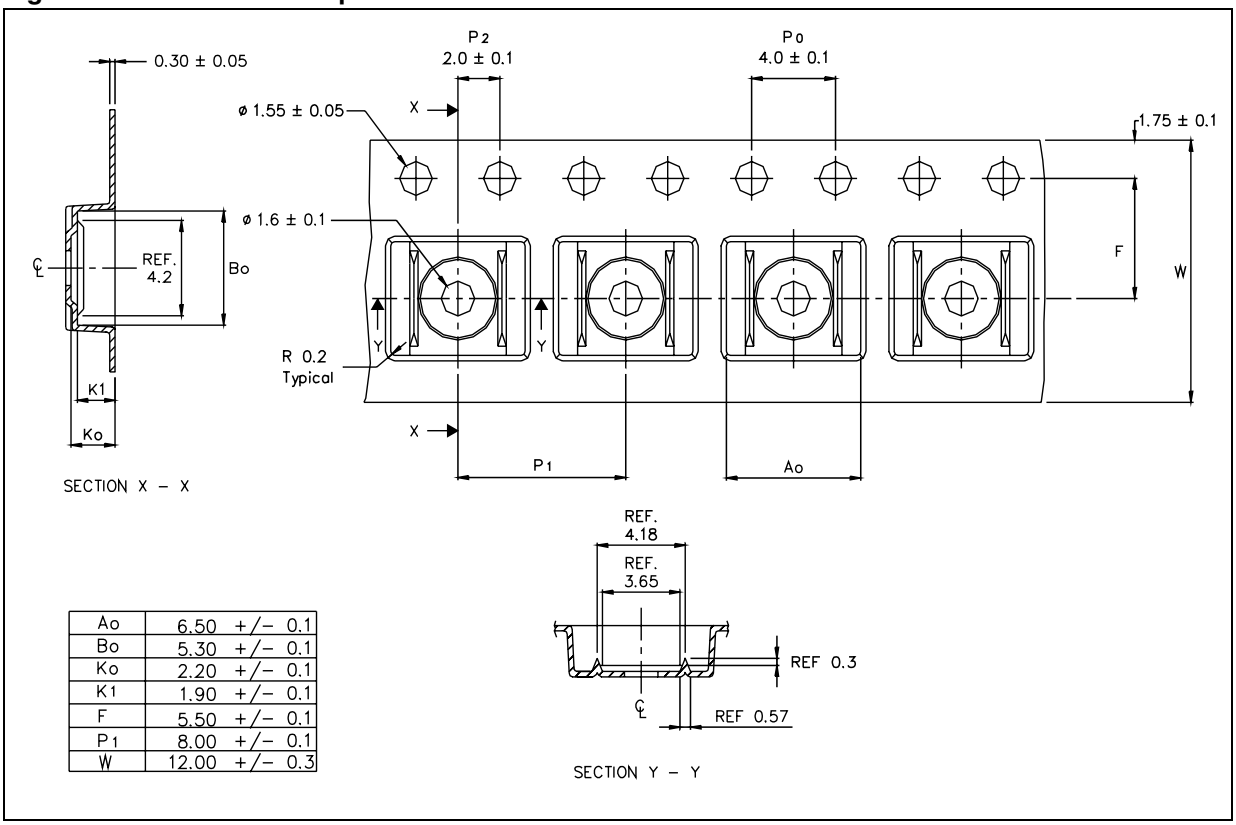
1. Drawing is not to scale.

Table 19. SO-8 mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.35	–	1.75	0.053	–	0.069
A1	0.10	–	0.25	0.004	–	0.010
A2	1.10	–	1.65	0.043	–	0.065
B	0.33	–	0.51	0.013	–	0.020
C	0.19	–	0.25	0.007	–	0.010
D(1)	4.80	–	5.00	0.189	–	0.197
E	3.80	–	4.00	0.15	–	0.157
e	–	1.27	–	–	0.050	–
H	5.80	–	6.20	0.228	–	0.244
h	0.25	–	0.50	0.010	–	0.020
L	0.40	–	1.27	0.016	–	0.050
k	0° (min.), 8° (max.)					
ddd	–	–	0.10	–	–	0.004

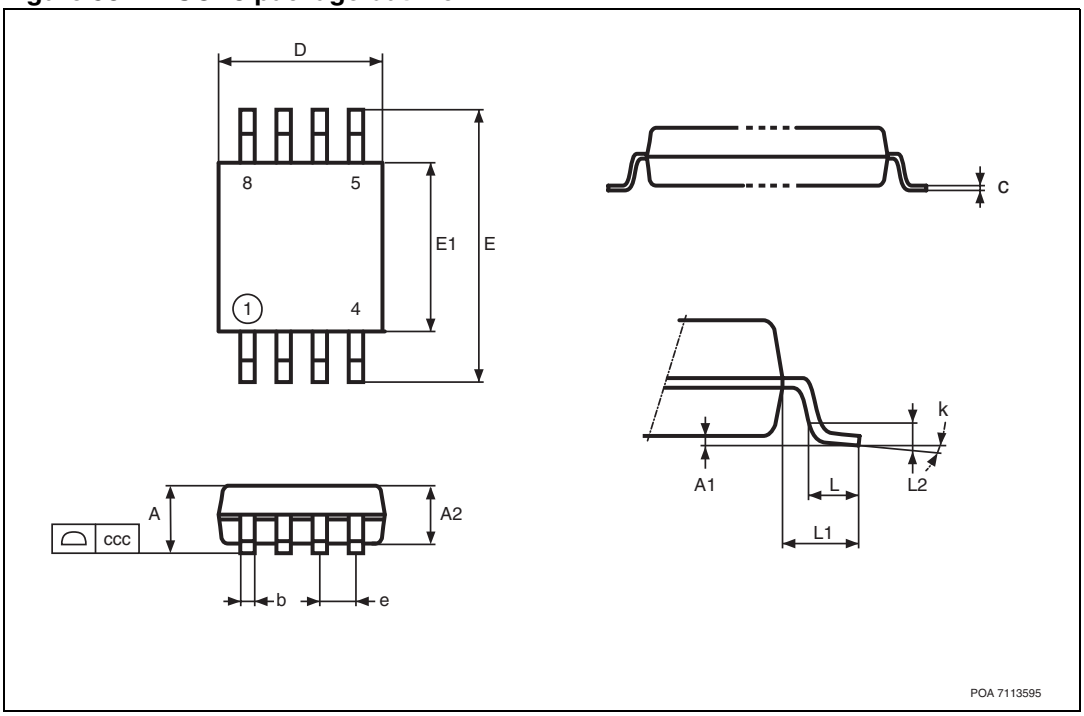
1. Dimension D does not include mold flash, protrusions or gate burrs. Mold flash, potrusions or gate burrs shall not exceed 0.15 mm (0.006 inch) in total (both sides).

Figure 57. SO-8 carrier tape



Ao	6.50 +/– 0.1
Bo	5.30 +/– 0.1
Ko	2.20 +/– 0.1
K1	1.90 +/– 0.1
F	5.50 +/– 0.1
P1	8.00 +/– 0.1
W	12.00 +/– 0.3

Figure 58. MSOP8 package outline

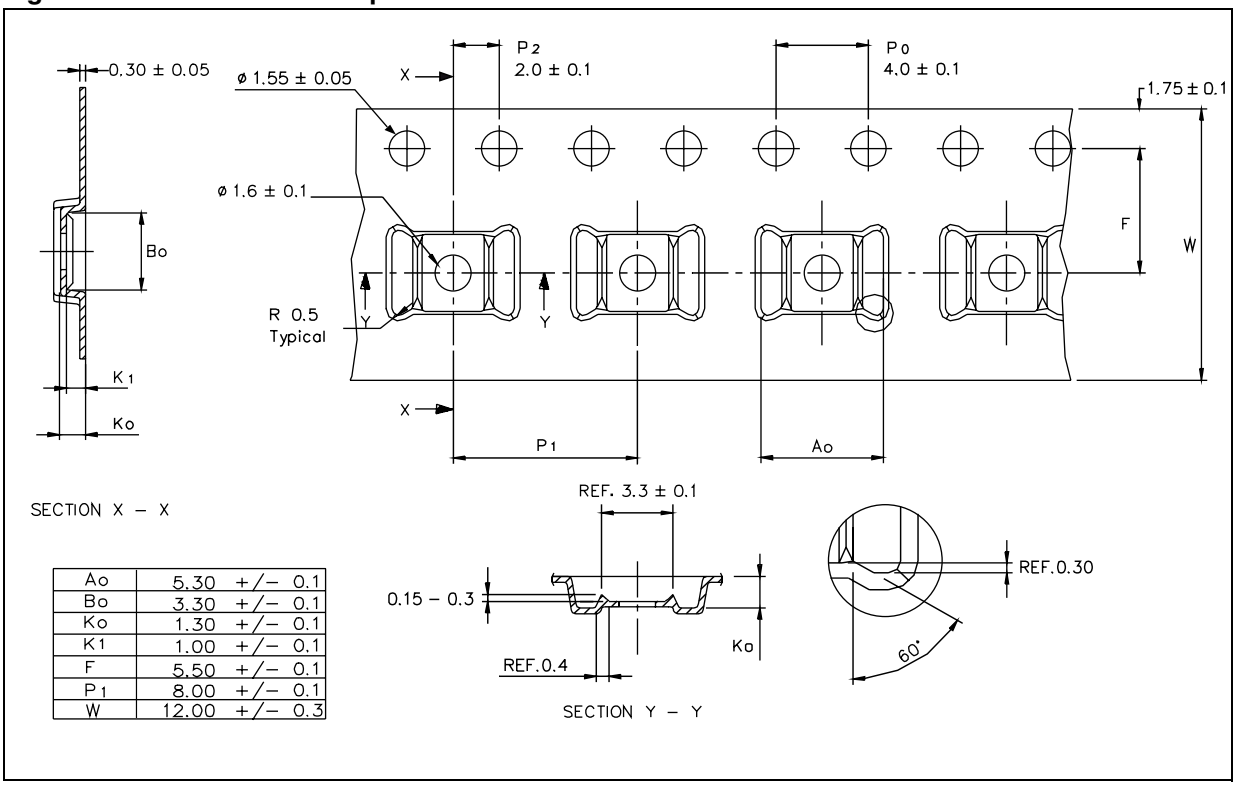


1. Drawing not to scale.

Table 20. MSOP8 package mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	–	–	1.10	–	–	0.043
A1	0.05	–	0.15	0.002	0.004	0.006
A2	0.75	0.85	0.95	0.031	0.034	0.037
b	0.25	–	0.40	0.010	0.013	0.016
c	0.13	–	0.23	0.005	0.007	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
E	4.65	4.90	5.15	0.187	0.193	0.199
E1	2.90	3.00	3.10	0.114	0.118	0.122
e	–	0.65	–	–	0.026	–
L	0.40	0.55	0.70	0.016	0.022	0.028
L1	–	0.95	–	–	0.037	
K	0°	–	6°	0°	–	6°
ccc			0.10			0.004

Figure 59. MSOP8 carrier tape



Ao	5.30 +/– 0.1
Bo	3.30 +/– 0.1
Ko	1.30 +/– 0.1
K1	1.00 +/– 0.1
F	5.50 +/– 0.1
P1	8.00 +/– 0.1
W	12.00 +/– 0.3

Figure 60. Reel information

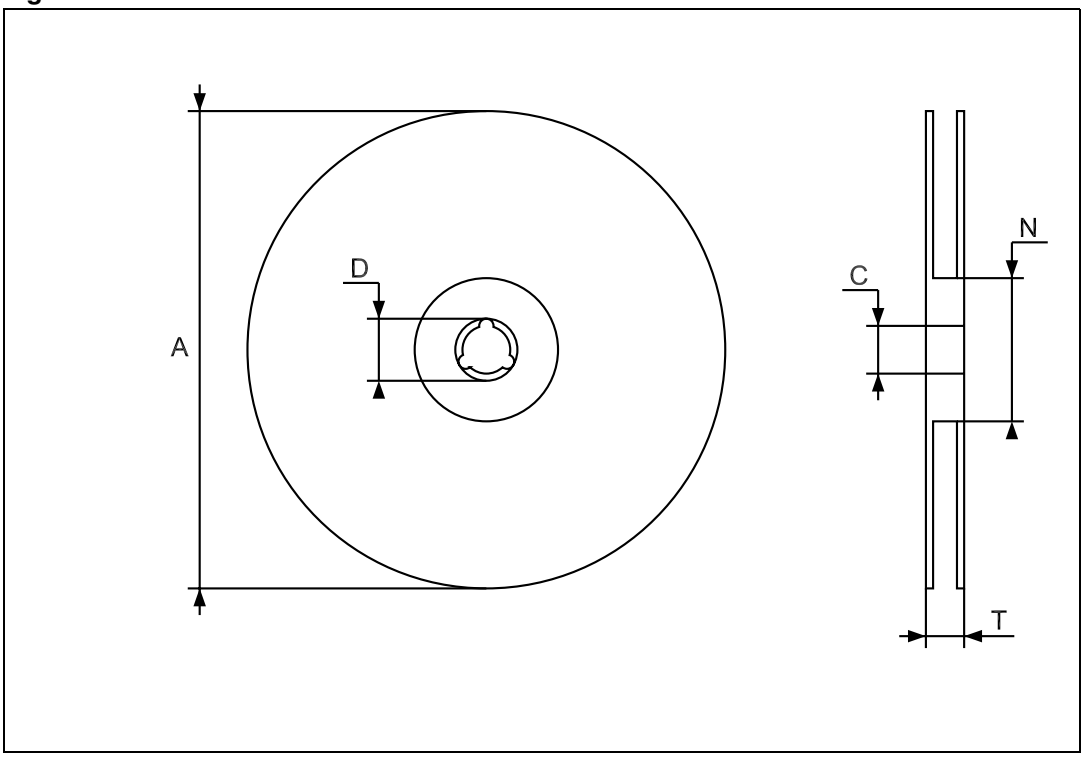


Table 21. Reel mechanical data

Symbol	Dimensions (mm)		
	Min.	Typ.	Max.
A SOT23-5L S0-8, MSOP8	–	–	 180 330
C	12.8	13.0	13.2
D	20.2	–	–
N	60	–	–
T	–	–	22.4

9 Ordering information

Table 22. Order codes

Part number	Package	Marking
STMPS2141MTR	SO-8	2141E
STMPS2151MTR		2151E
STMPS2161MTR		2161E
STMPS2171MTR		2171E
STMPS2141STR	SOT23-5L	2141
STMPS2151STR		2151
STMPS2161STR		2161
STMPS2171STR		2171
STMPS2141TTR	MSOP8	2141
STMPS2151TTR		2151
STMPS2161TTR		2161
STMPS2171TTR		2171

10 Revision history

Table 23. Document revision history

Date	Revision	Changes
01-Aug-2007	1	Initial release.
18-Dec-2007	2	Minor text changes, updated *Figure 53 on page 28*, added *Section 7: Detail device characteristics on page 16*.
24-Jan-2008	3	Footnote added in *Table 1 on page 1*, replaced *Figure 58 on page 32* and *Table 20 on page 32*, TSSOP8 package name replaced with MSOP8.
17-Jul-2009	4	Updated *Chapter 3*, test conditions modified for $I_{reverse}$ in *Table 12 on page 14* and *Chapter 7*. Added: *Figure 55*, *Figure 56*, *Figure 59*, *Figure 59* and *Figure 60*.
21-Nov-2012	5	Updated *Table 1* (replaced “Current limit” by “Rated continuous output current”). Updated values and units in *Table 4* to *Table 6*. Corrected *Figure 1* and *Figure 2* (replaced EN_N by EN). Replaced I_I by I_{IN}, I_{LIMIT} by I_{OS}, I_O by I_{OUT}, mS by ms, OC by FAULT, $R_{ds(on)}$ by R_{ON}, V_I and V_{CC} by V_{IN}, V_O by V_{OUT}, in the whole document. Updated *Section 5* (added cross-references). Updated *Table 9* and *Table 10* (replaced Tr by t_r), *Table 11* (updated test conditions). Updated *Table 15* (replaced Fault, OCx, and V_{OC} by FAULT). Updated *Table 16* (replaced V_{IENX} by V_{IEN}, mF by µF) . Updated titles of *Figure 3* to *Figure 52* (added conditions). Updated *Figure 3* to *Figure 16*, *Figure 25*, *Figure 26*, *Figure 28* to *Figure 41*, *Figure 50* and *Figure 51* (replaced R_L by I_L, mS by ms, and uF by µF). Updated *Figure 55*, *Figure 59*, and *Figure 59* (removed superfluous references to notes). Reformatted *Section 8* (moved *Figure 57 on page 31*). Removed *Figure 56*. Updated *Table 21* (added SOT23-5L, SO-8, and MSOP package and max. value for SOT23-5L package). Added *Section 9*. Minor corrections throughout document.
25-Jan-2013	6	Updated *Features* (added UL recognized components).

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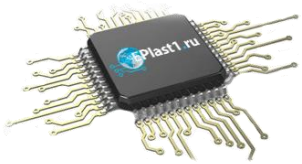

Как с нами связаться

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